# XN04505 (XN4505)

## Silicon NPN epitaxial planar type

For general amplification (Tr1)
For amplification of low-frequency output (Tr2)

#### ■ Features

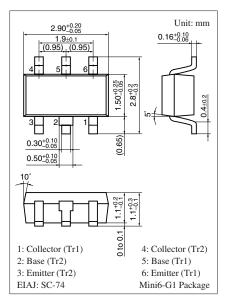
- Two elements incorporated into one package
- Reduction of the mounting area and assembly cost by one half

#### ■ Basic Part Number

• 2SD0601A (2SD601A) + 2SD1328

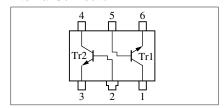
#### ■ Absolute Maximum Ratings $T_a = 25$ °C

	Parameter	Symbol	Rating	Unit	
Tr1	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	60	V	
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V	
	Emitter-base voltage (Collector open)	V <sub>EBO</sub>	7	V	
	Collector current	$I_C$	100	mA	
	Peak collector current	$I_{CP}$	200	mA	
Tr2	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	25	V	
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	
	Emitter-base voltage (Collector open)	V <sub>EBO</sub>	12	V	
	Collector current	$I_C$	0.5	A	
	Peak collector current	$I_{CP}$	1	A	
Overall	Total power dissipation	P <sub>T</sub>	300	mW	
	Junction temperature	$T_{j}$	150	°C	
	Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



Marking Symbol: DZ

#### Internal Connection



Note) The part number in the parenthesis shows conventional part number.



## ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

#### • Tr1

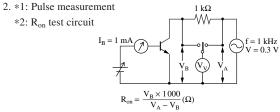
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \ \mu A, \ I_E = 0$	60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 2 \text{ mA}, I_B = 0$	50			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \ \mu A, I_C = 0$	7			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = 10 \text{ V}, I_{B} = 0$			100	μΑ
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$	160		460	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$		0.3	0.5	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		3.5		pF
(Common base, input open circuited)						

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### • Tr2

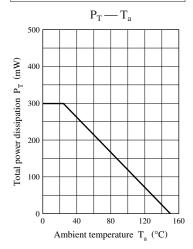
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \ \mu A, I_E = 0$	25			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \ \mu A, I_C = 0$	12			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$			0.1	μΑ
Forward current transfer ratio *1	h <sub>FE1</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	200		800	_
	h <sub>FE2</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 1 \text{ A}$	60			
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 20 \text{ mA}$		0.13	0.40	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 20 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		10		pF
(Common base, input open circuited)						
ON resistance *2	Ron			1.0		Ω

 $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7030 \ measuring \ methods \ for \ transistors.$ 

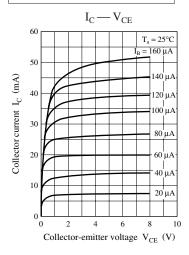


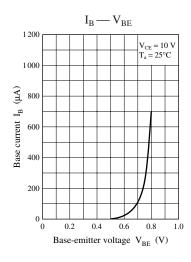
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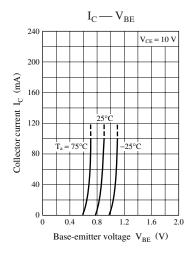
#### Common characteristics chart

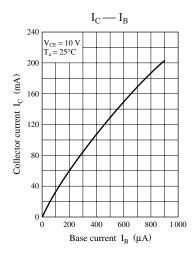


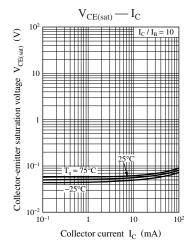
### Characteristics charts of Tr1

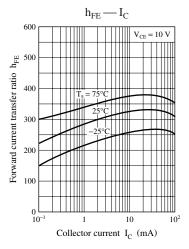




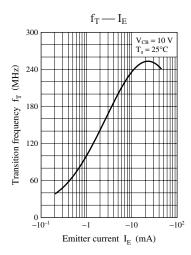




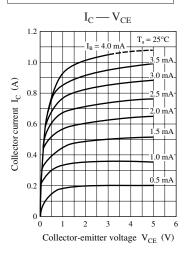


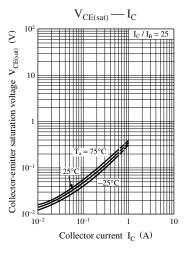


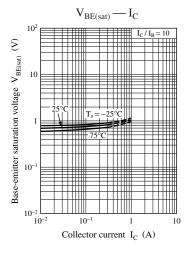
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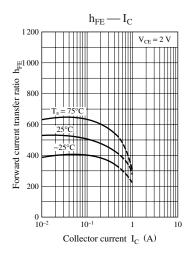


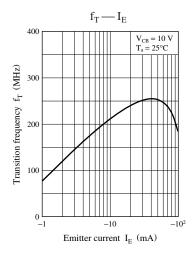
#### Characteristics charts of Tr2

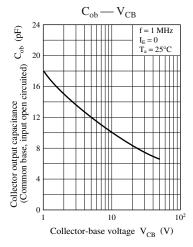












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